

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

## MCH6544

NPN Epitaxial Planar Silicon Transistor

### **Inverter Circuit / Driver Applications**

#### **Applications**

• Relay drivers, lamp drivers, motor drivers

#### **Features**

- · Composite type with an NPN transistor contained in one package facilitating high-density mounting
- · Ultrasmall package facilitates miniaturization in end products

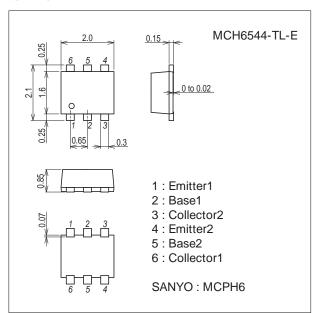
#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

| Parameter                    | Symbol | Conditions  | Ratings     | Unit |
|------------------------------|--------|---|-------------|------|
| Collector-to-Base Voltage    | VCBO   |   | 60          | V    |
| Collector-to-Emitter Voltage | VCEO   |   | 50          | V    |
| Emitter-to-Base Voltage      | VEBO   |   | 5           | V    |
| Collector Current            | IC     |   | 500         | mA   |
| Collector Current (Pulse)    | ICP    |   | 1.5         | Α    |
| Collector Dissipation        | PC     | When mounted on ceramic substrate (600mm <sup>2</sup> ×0.8mm) 1unit | 0.5         | W    |
| Total Power Dissipation      | PT     | When mounted on ceramic substrate (600mm <sup>2</sup> ×0.8mm)       | 0.55        | W    |
| Junction Temperature         | Tj     |   | 150         | C    |
| Storage Temperature          | Tstg   |   | -55 to +150 | C    |

#### **Package Dimensions**

unit : mm (typ) 7022A-011



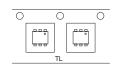
#### **Product & Package Information**

• Package : MCPH6

• JEITA, JEDEC : SC-88, SC-70-6, SOT-363

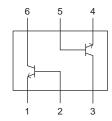
• Minimum Packing Quantity : 3,000 pcs./reel

#### Packing Type: TL Marking





#### **Electrical Connection**

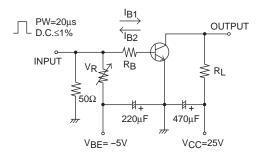


#### MCH6544

#### **Electrical Characteristics** at Ta=25°C

| Parameter                               | Symbol                | Conditions                                 | Ratings |     |     | Unit |
|---|-----------------------|--|---------|-----|-----|------|
|   |                       | Conditions                                 | min     | typ | max | Uill |
| Collector Cutoff Current                | ICBO                  | V <sub>CB</sub> =40V, I <sub>E</sub> =0A   |         |     | 100 | nA   |
| Emitter Cutoff Current                  | IEBO                  | V <sub>EB</sub> =4V, I <sub>C</sub> =0A    |         |     | 100 | nA   |
| DC Current Gain                         | hFE                   | V <sub>CE</sub> =2V, I <sub>C</sub> =10mA  | 300     |     | 800 |      |
| Gain-Bandwidth Product                  | f⊤                    | V <sub>CE</sub> =10V, I <sub>C</sub> =50mA |         | 500 |     | MHz  |
| Output Capacitance                      | Cob                   | V <sub>CB</sub> =10V, f=1MHz               |         | 2.8 |     | pF   |
| Collector-to-Emitter Saturation Voltage | V <sub>CE</sub> (sat) | IC=100mA, IB=10mA                          |         | 50  | 100 | mV   |
| Base-to-Emitter Saturation Voltage      | V <sub>BE</sub> (sat) | IC=100mA, IB=10mA                          |         | 0.9 | 1.2 | V    |
| Collector-to-Base Breakdown Voltage     | V(BR)CBO              | I <sub>C</sub> =10μA, I <sub>E</sub> =0A   | 60      |     |     | V    |
| Collector-to-Emitter Breakdown Voltage  | V(BR)CEO              | IC=1mA, RBE=∞                              | 50      |     |     | V    |
| Emitter-to-Base Breakdown Voltage       | V(BR)EBO              | IE=10μA, IC=0A                             | 5       |     |     | V    |
| Turn-ON Time                            | ton                   |  |         | 30  |     | ns   |
| Storage Time                            | t <sub>stg</sub>      | See specified Test Circuit.                |         | 340 |     | ns   |
| Fall Time                               | tf                    |  |         | 55  |     | ns   |

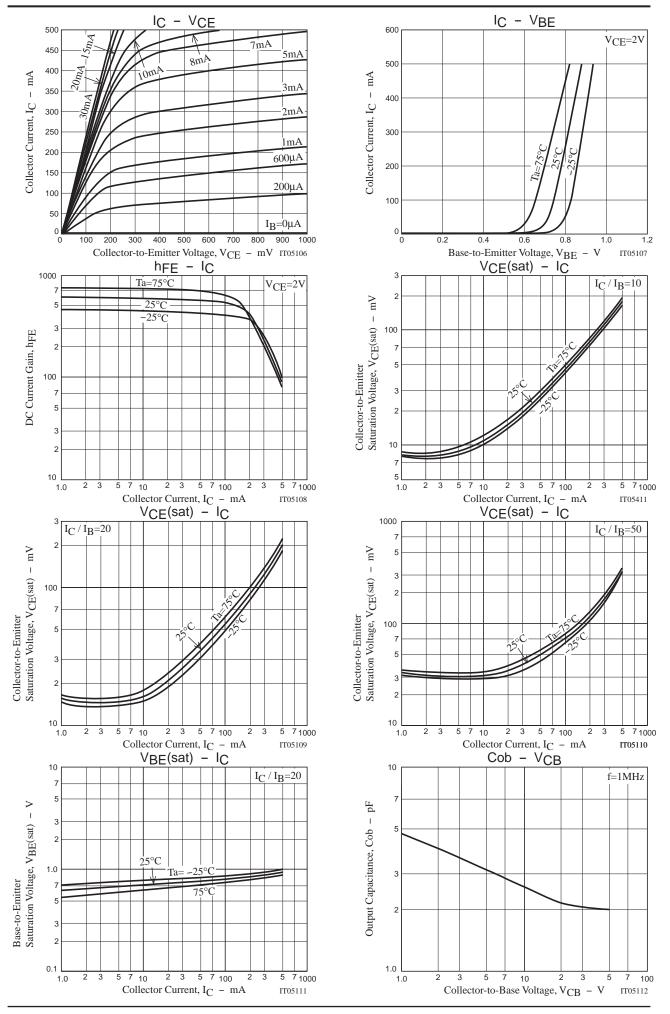
#### **Switching Time Test Circuit**



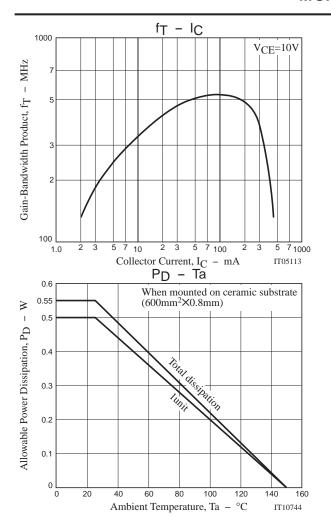
 $I_{C}=20I_{B1}=-20I_{B2}=200mA$ 

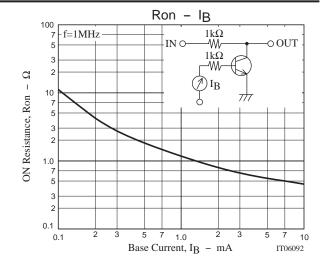
#### **Ordering Information**

| Device       | Package | Shipping       | memo    |  |
|--------------|---------|----------------|---------|--|
| MCH6544-TL-E | МСРН6   | 3,000pcs./reel | Pb Free |  |



#### MCH6544



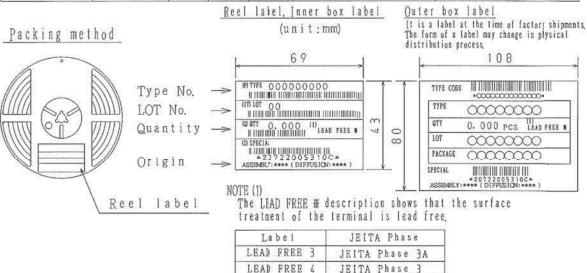


#### **Embossed Taping Specification**

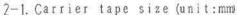
#### MCH6544-TL-E

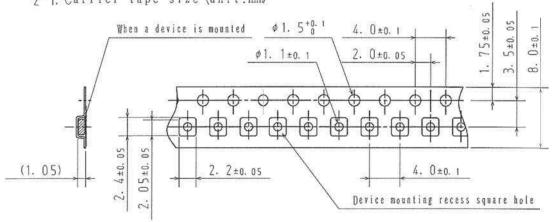
#### 1. Packing Format

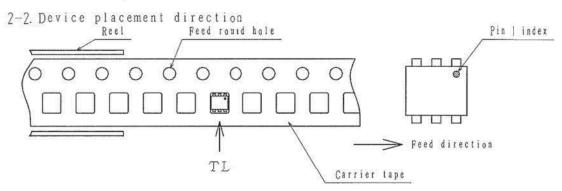
| Package Name Carrier 1 Type | Carrier Tape | Maximum Number of<br>devices contained (cs) |           |           | Packing format  |  |  |
|-----------------------------|--------------|---|-----------|-----------|---|--|--|
|                             | Туре         | Reel  | Inner box | Outer box | Inner BOX (C-1)                                       | Outer BOX (A-7)  |  |
| МСРН6                       | MCP4         | 3, 000                                      | 15, 000   | 90, 000   | 5 reels contained Dimensions:mm (external) 183×72×185 | 6 inner boxes contained<br>Dimensions:mm (external)<br>440×195×210 |  |



#### 2. Taping configuration







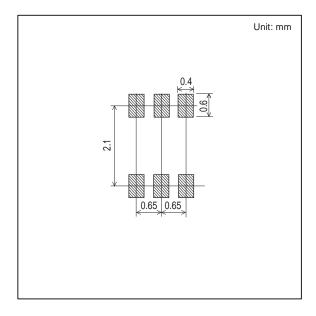
Those with pin 1 index on the feed hole side ·····TL

#### **Outline Drawing**

MCH6544-TL-E

## 

#### **Land Pattern Example**



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